

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
S-ENPOL CO., LTD.	03/30/2020
RECEIVING PARTY DATA	
Name:	ANKOR BIOPLASTICS CO., LTD.
Street Address:	216 MUNMAKGONGDAN-GIL MUNMAK--EUP
City:	WONJU-SI, GANGWON-DO
State/Country:	KOREA, REPUBLIC OF
Postal Code:	26362
PROPERTY NUMBERS Total: 2	
Property Type	Number
Patent Number:	6713595
Patent Number:	6399716
CORRESPONDENCE DATA	
Fax Number:	(212)661-8002
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	2126618000
Email:	info@lmiplaw.com
Correspondent Name:	LUCAS & MERCANTI LLP
Address Line 1:	30 BROAD ST
Address Line 2:	21ST FLOOR
Address Line 4:	NEW YORK, NEW YORK 10004
ATTORNEY DOCKET NUMBER:	J&K-72
NAME OF SUBMITTER:	YUN H. CHOE
SIGNATURE:	/Yun H. Choe/
DATE SIGNED:	05/05/2020
Total Attachments: 2	
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ASSIGNMENT

S-ENPOL CO., LTD., a corporation duly organized under and pursuant to the laws of **REPUBLIC OF KOREA**, and having its principal place of business at **5-29 BANGYE-RI, MUNMAK-EUP, WONJU-SI, GANGWON-DO, KOREA, REPUBLIC OF 220-805** (herein referred to as "Assignor") owns certain right, title and interest in any Letters Patent(s) ("said patent(s)") and any Patent application(s) ("said application(s)") set forth below, as well as any invention(s) ("said invention(s)") disclosed in said application(s) and said patent(s).

Patent(s)

US Patent No.: 6,713,595		Issue Date: 03-30-2004	
Title:	COPOLYESTER RESIN COMPOSITION AND A PROCESS OF PREPARATION THEREOF		
US Patent No.: 6,399,716		Issue Date: 06-04-2002	
Title:	COPOLYESTER RESIN COMPOSITION AND A PROCESS OF PREPARATION THEREOF		

WHEREAS, **ANKOR BIOPLASTICS CO., LTD.**, corporations duly organized under and pursuant to the laws of **REPUBLIC OF KOREA**, and having its principal place of business at, 216, Munmakgongdan-gil Munmak-eup, Wonju-si, Gangwon-do, Republic of Korea. 26362 (herein referred to as "Assignee"), is desirous of acquiring the Assignor's ENTIRE right, title, and interest in and to said invention(s), said application(s), and said patent(s), the right to file applications on said invention(s), the Assignor's entire right, title and interest in and to any applications for Letters Patent of the United States or other countries claiming priority to said application(s), the right to recover damages, including provisional or other royalties, for prior infringements of said application(s) and said patent(s), and the Assignor's entire right, title, and interest in and to any Letters Patent or Patents, United States or foreign, to be obtained for said invention(s) and said application(s);

WHEREAS, the Assignor and Assignee have entered into an Agreement prior to this Assignment;

NOW, THEREFORE, the Assignor and Assignee confirm and agree that, for good and valuable consideration and according to the terms and conditions as set forth in the their Agreement, the Assignor has sold, assigned, transferred, and set over, and by these presents does sell, assign, transfer, and set over, unto the Assignee, its successors, legal representatives, and assigns the Assignor's entire right, title, and interest in and to said invention(s), said application(s), and said patent(s), the right to file applications on said invention(s), the Assignor's entire right, title and interest in and to any applications for Letters Patent of the

United States or other countries claiming priority to said application(s), including divisions, continuations, and continuations-in-part of said application(s), the right to recover damages, including provisional or other royalties, for prior infringements of said application(s) and said patent(s), the Assignor's entire right, title and interest in and to any and all Letters Patent or Patents, United States or foreign, to be obtained for said invention(s) and said application(s), the Assignor's entire right, title and interest in and to any and all reissues and extensions of said patent(s), and all rights under the Hague Convention, the Paris Convention for the Protection of Industrial Property, and under the Patent Cooperation Treaty, the same to be held and enjoyed by the Assignee, for its own use and behalf and the use and behalf of its successors, legal representatives, and assigns, to the full end of the term or terms for which Letters Patent or Patents may be granted as fully and Assignor's entirely as the same would have been held and enjoyed by the Assignor had this sale and assignment not been made;

AND for the same consideration, the Assignor hereby covenants and agrees to and with the Assignee, its successors, legal representatives, and assigns that the Assignor will, whenever counsel of the Assignee, or the counsel of its successors, legal representatives, and assigns, shall advise that any proceeding in connection with said invention(s), said application(s), said patent(s), any application claiming priority to said application(s), any reissue or extension of said patent(s), and any United States or foreign Letters Patent or Patents for said invention(s) or said application(s), including interference proceedings, is lawful and desirable, sign all papers and documents, take all lawful oaths, and do all acts necessary or required to be done for the procurement, maintenance, enforcement and defense of Letters Patent or Patents for said invention(s), without charge to the Assignee, its successors, legal representatives, and assigns, but at the cost and expense of the Assignee, its successors, legal representatives, and assigns;

AND the Assignor hereby requests the Commissioner of Patents to issue any and all aforementioned patent(s) of the United States to the Assignee, as the Assignee of said invention(s) and the Letters Patent to be issued thereon for the sole use and behalf of the Assignee, its successors, legal representatives, and assigns.

Date: March 30, 2020

Signature: *Kim*

Company: S-ENPOL CO., LTD.

Title & Name: CEO KIM SEIHOON

Date: March 30, 2020

Signature: *[Signature]*

Company: ANKOR BIOPLASTICS CO., LTD.

Title & Name: CEO LIM HZEN
Young